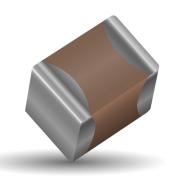
General Specifications



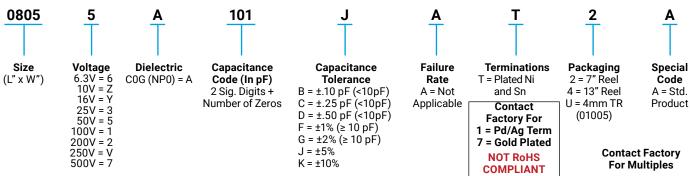


COG (NP0) is the most popular formulation of the "temperature-compensating," EIA Class I ceramic materials. Modern COG (NP0) formulations contain neodymium, samarium and other rare earth oxides.

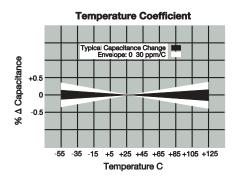
COG (NP0) ceramics offer one of the most stable capacitor dielectrics available. Capacitance change with temperature is 0 ± 30 ppm/°C which is less than $\pm0.3\%$ C from -55°C to +125°C. Capacitance drift or hysteresis for COG (NP0) ceramics is negligible at less than $\pm0.05\%$ versus up to $\pm2\%$ for films. Typical capacitance change with life is less than $\pm0.1\%$ for COG (NP0), one-fifth that shown by most other dielectrics. COG (NP0) formulations show no aging characteristics.

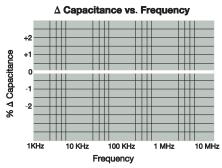
PART NUMBER (see page 4 for complete part number explanation)

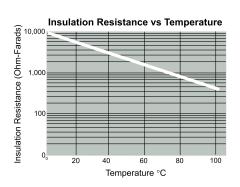


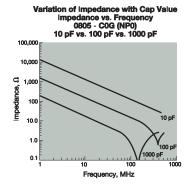


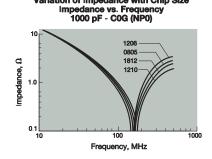
NOTE: Contact factory for availability of Termination and Tolerance Options for Specific Part Numbers. Contact factory for non-specified capacitance values.



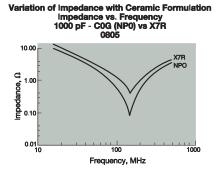








Variation of Impedance with Chip Size



Specifications and Test Methods



Parame	ter/Test	NP0 Specification Limits Measuring Conditions								
Operating Tem	perature Range	-55°C to +125°C	Temperature Cycle Chamber							
-	itance Q	Within specified tolerance <30 pF: Q≥ 400+20 x Cap Value ≥30 pF: Q≥ 1000	Freq.: 1.0 MHz ± 10% for cap ≤ 1000 pF 1.0 kHz ± 10% for cap > 1000 pF Voltage: 1.0Vrms ± .2V							
Insulation	Resistance	100,000MΩ or 1000MΩ - μ F, whichever is less	Charge device with rated voltage for 60 ± 5 secs @ room temp/humidity							
Dielectric	: Strength	No breakdown or visual defects	Charge device with 250% of rated voltage for 1-5 seconds, w/charge and discharge current limited to 50 mA (max) Note: Charge device with 150% of rated voltage for 500V devices.							
	Appearance	No defects								
Resistance to	Capacitance Variation	±5% or ±.5 pF, whichever is greater	Deflection: 2mm Test Time: 30 seconds 1 mm/sec							
Flexure	Q	Meets Initial Values (As Above)	V							
Stresses	Insulation Resistance	≥ Initial Value x 0.3	90 mm							
Solder	rability	≥ 95% of each terminal should be covered with fresh solder	Dip device in eutectic sol ± 0.5 se							
	Appearance	No defects, <25% leaching of either end terminal								
	Capacitance Variation	≤ ±2.5% or ±.25 pF, whichever is greater	Dip device in eutectic solder at 260°C for 60sec- onds. Store at room temperature for 24 ± 2hours before measuring electrical properties.							
Resistance to Solder Heat	Q	Meets Initial Values (As Above)								
Solder Heat	Insulation Resistance	Meets Initial Values (As Above)								
	Dielectric Strength	Meets Initial Values (As Above)								
	Appearance	No visual defects	Step 1: -55°C ± 2°	30 ± 3 minutes						
	Capacitance Variation	≤ ±2.5% or ±.25 pF, whichever is greater	Step 2: Room Temp	≤ 3 minutes						
Thermal Shock	Q	Meets Initial Values (As Above)	Step 3: +125°C ± 2°	30 ± 3 minutes						
	Insulation Resistance	Meets Initial Values (As Above)	Step 4: Room Temp	≤ 3 minutes						
	Dielectric Strength	Meets Initial Values (As Above)	Repeat for 5 cycles and measure after 24 hours at room temperature							
	Appearance	No visual defects	_							
	Capacitance Variation	≤ ±3.0% or ± .3 pF, whichever is greater	Charge device with twice rated voltage in test chamber set at 125°C ± 2°C							
Load Life	Q (C=Nominal Cap)	≥ 30 pF: Q≥ 350 ≥10 pF, <30 pF: Q≥ 275 +5C/2 <10 pF: Q≥ 200 +10C	for 1000 hours (+48, -0). Remove from test chamber and stabilize at room temperature for 24 hours before measuring.							
	Insulation Resistance	≥ Initial Value x 0.3 (See Above)								
	Dielectric Strength	Meets Initial Values (As Above)								
	Appearance	No visual defects								
	Capacitance Variation	≤ ±5.0% or ± .5 pF, whichever is greater	Store in a test chamber s	et at 85°C ± 2°C/ 85% ±						
Load Humidity	Q	≥ 30 pF: Q≥ 350 ≥10 pF, <30 pF: Q≥ 275 +5C/2 <10 pF: Q≥ 200 +10C	5% relative humidi (+48, -0) with rated	l voltage applied.						
	Insulation Resistance	≥ Initial Value x 0.3 (See Above)	Remove from chamber temperature for 24 ± 2 h							
	Dielectric Strength	Meets Initial Values (As Above)								

Capacitance Range



PREFERRED SIZES ARE SHADED

SIZE 0101*			1*	0201 0402				0603					0805						1206									
Soldering Reflow Only				Reflow Only Reflow/Wave			ave		Reflow/Wave					Reflow/Wave						Reflow/Wave								
Pack	Packaging All Paper				All Paper All Paper				All Paper						Paper	/Emboss	sed		Paper/Embossed									
(L) Length	mm	0.40 ± 0					1.00 ± 0.10 (0.040 ± 0.004)				1.60 ± 0.15				2.01 ± 0.20						3.20 ± 0.20							
	(in.) mm	0.20 ±		0.30 ±						(0.063 ± 0.006) 0.81 ± 0.15					(0.079 ± 0.008) 1.25 ± 0.20						(0.126 ± 0.008) 1.60 ± 0.20							
W) Width	W) Width (in.) (0.008 ± 0.0008)					(0.020 ± 0.004)		(0.032 ± 0.006)					(0.049 ± 0.008)						(0.063 ± 0.008)									
(t) Terminal	mm (in.)	0.10 ± 0 (0.004 ± 0		0.15 ± (0.006 ±		0.25 ± 0.15 (0.010 ± 0.006)					.35 ± 0. 014 ± 0.						50 ± 0.25 20 ± 0.01						0.50 ± 0. .020 ± 0.					
	WVDC	16		25	50	16	25	50	16	25	50	100	200	16	25	50	100	200	250	16	25	50	100	200	250	500		
Cap (pF)	0.5 1.0	D		A	A	C	CC	C	G G	G G	G G	G G		J	J	J	J	J		J	J	J	J	J		J		
(pr)	1.0	B B		A A	A	C	С	С	G	G	G	G		J	J	J	J	J		J	J	J	J	J		J		
	1.5	В		Α	A	С	С	С	G	G	G	G		J	J	J	J	J		J	J	J	J	J		J		
	1.8 2.2	B B		A A	A	C	C	C	G G	G	G G	G G		J	J	J	J	J		J	J	J	J	J		J		
	2.7	В		Α	Α	С	С	С	G	G	G	G		J	J	J	J	J		J	J	J	J	J		J		
	3.3 3.9	B B		A A	A	C	C	C	G G	G	G G	G G		J	J	J	J	J		J	J	J	J	J		J		
	4.7	В		Α	Α	С	С	С	G	G	G	G		J	J	J	J	J		J	J	J	J	J		J		
	5.6 6.8	B B		A A	A	C	C	C	G G	G G	G G	G G		J	J	J	J	J		J	J	J	J	J		J		
	8.2	В		Α	Α	С	С	С	G	G	G	G		J	J	J	J	J		J	J	J	J	J		J		
	10 12	B B		A A	A	C	C	C	G G	G G	G G	G G	G G	J	J	J	J	J	N N	J	J	J	J	J	J	J		
	15	В		Α	Α	С	С	С	G	G	G	G	G	J	J	J	J	J	N	J	J	J	J	J	J	J		
	18 22	B B		A A	A	C	C	C	G G	G	G G	G G	G G	J	J	J	J	J	N N	J	J	J	J	J	J J	J		
	27	В		Α	Α	С	С	С	G	G	G	G	G	J	J	J	J	J	N	J	J	J	J	J	J	J		
	33 39	B B		A A	A	C	C	C	G G	G	G G	G G	G G	J	J	J	J	J	N N	J	J	J	J	J	J	J		
	47	В		Α	Α	С	С	С	G	G	G	G	G	J	J	J	J	J	N	J	J	J	J	J	Ĵ	J		
	56 68	B B		A A	A	C	C	C	G G	G G	G G	G G	G G	J	J	J	J	J	N N	J	J	J	J	J		J		
	82	В		Α	Α	С	С	С	G	G	G	G	G	J	J	J	J	J	N	J	J	J	J	J		J		
	100 120	В		Α	Α	C	C	C	G G	G	G G	G G	G G	J J	J	J	J	J	N N	J	J	J	J	J		J		
	150					С	С	С	G	G	G	G	G	J	J	J	J	J	N	J	J	J	J	J		J		
	180 220					C	C	C	G G	G G	G G	G G	G G	J	J	J	J	J	N N	J	J	J	J	J		J M		
	270					С	С	С	G	G	G	G	Ü	J	J	J	J	J	N	J	J	J	J	J		М		
	330 390					C	C	C	G G	G	G G	G G		J	J	J	J	J	N	J	J	J	J	J		M M		
	470					С	С	С	G	G	G	G		J	J	J	J	J		J	J	J	J	J		М		
	560 680					C	C	C	G G	G	G G	G G		J	J	J	J	J		J	J	J	J	J		M P		
	820					С	С	С	G	G	G	G		J	J	J	J	J		J	J	J	J	М				
	1000 1200					С	С	С	G	G	G G	G		J	J	J	J	J		J	J	J	J	Q Q				
	1500								G	G	G			J	J	J	J			J	J	J	М	Q				
	1800 2200								G G	G G	G G			J N	J	J N	N N			J	J	M M	M P	Q Q				
	2700								G	G	G			N	N	N	N			J	J	М	Р	Q				
	3300 3900								G G	G	G G			P P	N P	N P	N N			J	J	M M	P P	Q				
	4700								G	G	G			Р	Р	Р	N			J	J	М	Р					
	5600 6800						ارا							P P	P P	P P				J M	J M	M	P P					
Сар	8200 0.010	-	_	۔		<u></u>	1	N-,						P P	P P	P P			-	M P	M P	M P	P P					
Cap (μF)	0.012		~	ج	\leq) -	T					Р	Р	Р												
	0.015 0.018		_ (() 〕)	لمر	ノ_	<u> </u>	_				P P	P P	P P						-						
	0.022				<u> </u>		and and							P	P	P												
	0.027		_		⁴ t				_												-	-						
	0.039		- 1		' `	<u> </u>		ĺ	ĺ																			
	0.047	-	-																-		_							
	0.082																											
	0.1											46.	00.7				46.7						40.7	0.00	0.51			
	/DC	16		25	50	16	25	50	16	25	50	100	200	16	25	50	100	200	250	16	25	50	100	200	250	500		
SI	ZE	0101	1*	02	01		0402				0603						0805						1206					
Letter	А	В	С		E	G		J		K		М	N	1		-	Q		Х		Υ		Z					
Max		0.22	0.56	0	71	ე ფი		0.94		1.02		1.27	1.	₄₀	1	52	1.7	В	2.29		2.54	2	.79					
Max. Thickness	0.33	0.22 (0.009)	0.56 (0.022)	0.0	71 ()28)	0.90		0.94 (0.037)		1.02 (0.040)		1.27 0.050)	1.4 (0.0			52 060)	1.75 (0.07		2.29 (0.090)		2.54).100)		.79 110)					

Capacitance Range



PREFERRED SIZES ARE SHADED

SIZ	E	1210					1812					1825				2220					
Solde				Reflow Onl	y		Reflow Only						Reflow Only			Reflow Onl	ly	2225 Reflow Only			
Packa	ging	Paper/Embossed						,	All Embosse	A	All Embosse	ed	A	All Emboss	ed	Al	d				
(L) Length	mm (in.)		((3.20 ± 0.20 0.126 ± 0.00			4.50 ± 0.30 (0.177 ± 0.012)					4.50 ± 0.30 (0.177 ± 0.012)				5.70 ± 0.40 0.225 ± 0.0		(0.:			
W) Width	mm	2.50 ± 0.20					3.20 ± 0.20					6.40 ± 0.40				5.00 ± 0.40	0	6			
	(in.) mm	(0.098 ± 0.008) 0.50 ± 0.25						(0.126 ± 0.008) 0.61 ± 0.36					0.252 ± 0.01 0.61 ± 0.36			0.64 ± 0.0			250 ± 0.01 .64 ± 0.39		
(t) Terminal	(in.)			0.020 ± 0.0	10)				0.024 ± 0.01	4)		(0	(0.024 ± 0.014)			(0.025 ± 0.015)			25 ± 0.01	5)	
Сар	WVDC 0.5	25	50	100	200	500	25	50	100	200	500	50	100	200	50	100	200	50	100	200	
(pF)	1.0																				
	1.2 1.5																				
	1.8 2.2																ı į	-	- K 14		
	2.7															4			\sim	1	
	3.3								İ) ੍ਰ ੈਂT	
	3.9 4.7																<u></u>				
	5.6 6.8																	4			
	8.2																1 1			1	
	10 12					J															
	15					J															
	18 22					٦ ر															
	27					J															
	33 39					ر ر															
	47					J															
	56 68					J															
	82					J															
	100 120					ر ر															
	150					J															
	180 220					J															
	270					J															
	330 390					J M															
	470					М															
	560 680	J	J	J	J K	M P															
	820	J	J	J	К	Р															
	1000 1200	J P	J P	P P	P P	P P	K K	K K	N N	N N	M M	M M	M M	M M				M M	M M	P P	
	1500	Р	Р	Р	Р	Р	K	К	N	N	М	М	М	М				М	М	Р	
	1800 2200	P P	P P	P P	P P	P N	K K	K K	N N	N N	M P	M X	M X	M M				M M	M M	P P	
	2700	Р	Р	Р	Р		K	К	N	Р	Q	х	х	М				М	М	Р	
	3300 3900	P P	P P	P P	P		K K	K K	N N	P P	Q Q	X	X X	X X			X X	M M	M M	P P	
	4700	P	Р	P			K	К	N	P	Υ	Х	Х	Х	X	X	Х	М	М	P	
	5600 6800	P P	P P	P P			K K	K K	P Q	P Q	Y	X X	X X	X X	X X	X X	X X	M M	M M	P P	
Con	8200	P	P				K	M	Q	Q		X	X	X	X	X	X	M	M	P	
Cap (pF)	0.010 0.012	N N	N N				K K	M M	Q Q	Q		X X	X X	X X	X X	X X	X X	M M	M M	P P	
	0.015						P P	P P	Q			X	X	X	X	X	X	M	M	Y	
	0.018 0.022						P	P	Q Q			X	X X	X	X X	X	X	M M	M Y	Y	
	0.027						Q	Q	X			X	X	Υ	X	X		P	Y	Y	
	0.033 0.039						Q X	Q X	X X			X X	Х		X Y	X		X X	Y Y	Y	
	0.047 0.068		-	-			X Z	X Z	X			Х			Y Z			X	Z Z		
	0.082						Z	z	Y						z			Х	Z		
	0.1 WVDC	25	50	100	200	ECO	Z 25	Z	Z 100	200	500	F0	100	200	Z 50	100	200	Z	Z 100	200	
	SIZE	25	50	1210	200	500	25	50	1812	200	500	50	1825	200	50	2220	200	50	2225	200	
Late					-					1		N I						-			
Letter Max.	0.33	0.22	,	C 0.56	0.71	G 0.90)	J 0.94	1.02	1.2	7	N 1.40	P 1.52	Q 1.7		X 2.29	Y 2.54	2.7			
Thickness	(0.013)	(0.00		0.022)	(0.028)	(0.03		0.94	(0.040)	(0.05		(0.055)	(0.060)	(0.0		0.090)	(0.100)	(0.1			
				PAP	ER								EME	BOSSED							



IMPORTANT INFORMATION/DISCLAIMER

All product specifications, statements, information and data (collectively, the "Information") in this datasheet or made available on the website are subject to change. The customer is responsible for checking and verifying the extent to which the Information contained in this publication is applicable to an order at the time the order is placed. All Information given herein is believed to be accurate and reliable, but it is presented without guarantee, warranty, or responsibility of any kind, expressed or implied.

Statements of suitability for certain applications are based on AVX's knowledge of typical operating conditions for such applications, but are not intended to constitute and AVX specifically disclaims any warranty concerning suitability for a specific customer application or use.

ANY USE OF PRODUCT OUTSIDE OF SPECIFICATIONS OR ANY STORAGE OR INSTALLATION INCONSISTENT WITH PRODUCT GUIDANCE VOIDS ANY WARRANTY.

The Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by AVX with reference to the use of AVX's products is given without regard, and AVX assumes no obligation or liability for the advice given or results obtained.

Although AVX designs and manufactures its products to the most stringent quality and safety standards, given the current state of the art, isolated component failures may still occur. Accordingly, customer applications which require a high degree of reliability or safety should employ suitable designs or other safeguards (such as installation of protective circuitry or redundancies) in order to ensure that the failure of an electrical component does not result in a risk of personal injury or property damage.

Unless specifically agreed to in writing, AVX has not tested or certified its products, services or deliverables for use in high risk applications including medical life support, medical device, direct physical patient contact, water treatment, nuclear facilities, weapon systems, mass and air transportation control, flammable environments, or any other potentially life critical uses. Customer understands and agrees that AVX makes no assurances that the products, services or deliverables are suitable for any high-risk uses. Under no circumstances does AVX warrant or guarantee suitability for any customer design or manufacturing process.

Although all product-related warnings, cautions and notes must be observed, the customer should not assume that all safety measures are indicted or that other measures may not be required.